



**Product data sheet** 

### 1. General description

Hyperfast power diode in a SOD59 (2-lead TO-220AC) plastic package.

#### 2. Features and benefits

- Fast switching
- Low leakage current
- Low reverse recovery current
- Low thermal resistance
- · Reduces switching losses in associated MOSFET or IGBT

### 3. Applications

- Active PFC in air conditioner
- · High frequency switched-mode power supplies
- Continuous Current Mode (CCM) Power Factor Correction (PFC)

### 4. Quick reference data

Table 1. Q	uick reference data						
Symbol	Parameter	Conditions	Values				Unit
Absolute	maximum rating						
$V_{\text{RRM}}$	repetitive peak reverse voltage		600			V	
$I_{F(AV)}$	average forward current	δ = 0.5; T <sub>mb</sub> ≤ 121 °C; square-wave pulse; Fig. 1; Fig. 2; Fig. 3	15			A	
I <sub>FRM</sub>	repetitive peak forward current	$\delta$ = 0.5; t <sub>p</sub> = 25 µs; T <sub>mb</sub> ≤ 121 °C; square-wave pulse	30			A	
I <sub>FSM</sub>	non-repetitive peak forward current	$t_{\rm p}$ = 10 ms; $T_{\rm j(init)}$ = 25 °C; sine-wave pulse; <u>Fig. 4</u>	180			A	
		$t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	200		А		
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	aracteristics					-	
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 15 A; T <sub>j</sub> = 150 °C; <u>Fig. 6</u>	- 1.4 2		2	V	
Dynamic	characteristics						
t <sub>rr</sub>	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$		-	13	18	ns

# 5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode	mb	
2	А	anode	۲ O f	К-Ң-А
mb	mb	mounting base; connected to cathode	C	001aaa020

# 6. Ordering information

Table 3. Ordering information					
Type number	Fype number Package				
	Name	Description	Version		
BYC15-600P	TO-220AC	plastic single-ended package; heatsink mounted; 1 mounting hole; 2-lead TO-220AC	SOD59		

# 7. Marking

Table 4. Marking codes						
Type number	Marking codes					
BYC15-600P	BYC15-600P					

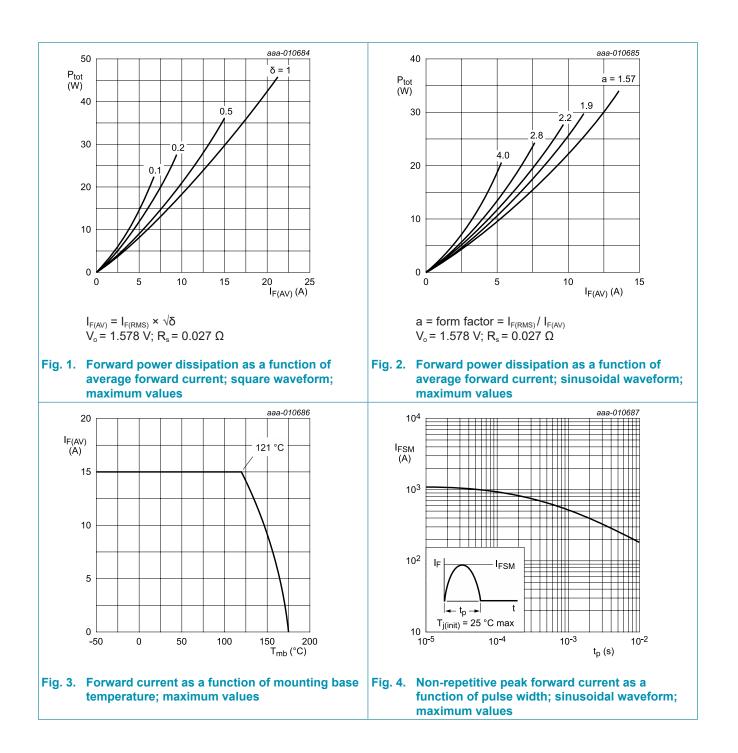
# 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

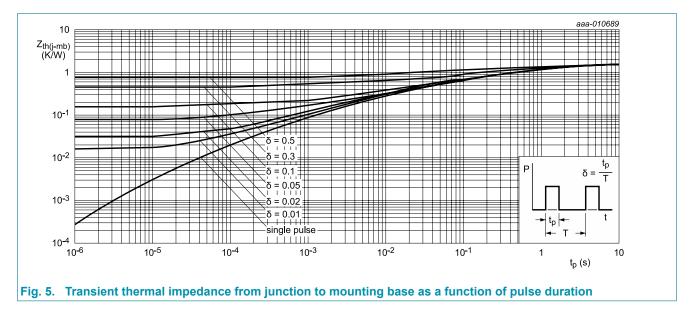
Symbol	Parameter	Conditions	Values	Unit
V <sub>RRM</sub>	repetitive peak reverse voltage		600	V
V <sub>RWM</sub>	crest working reverse voltage		600	V
V <sub>R</sub>	reverse voltage	DC	600	V
I <sub>F(AV)</sub>	average forward current	δ = 0.5 ; T <sub>mb</sub> ≤ 121 °C; square-wave pulse; Fig. 1; Fig. 2; Fig. 3	15	A
I <sub>FRM</sub>	repetitive peak forward current	δ = 0.5; t <sub>p</sub> = 25 μs; T <sub>mb</sub> ≤ 121 °C; square-wave pulse	30	А
I <sub>FSM</sub>	non-repetitive peak forward current	t <sub>p</sub> = 10 ms; T <sub>j(init)</sub> = 25 °C; sine-wave pulse; Fig. 4	180	A
		$t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	200	А
T <sub>stg</sub>	storage temperature		-65 to 175	°C
Tj	junction temperature		175	°C

BYC15-600P Hyperfast power diode



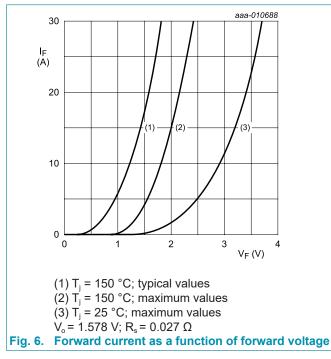
# 9. Thermal characteristics

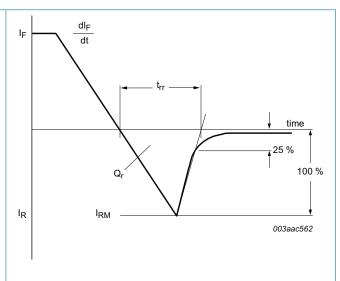
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base	with heatsink compound; Fig. 5	-	-	1.5	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient	in free air	-	60	-	K/W



### **10. Characteristics**

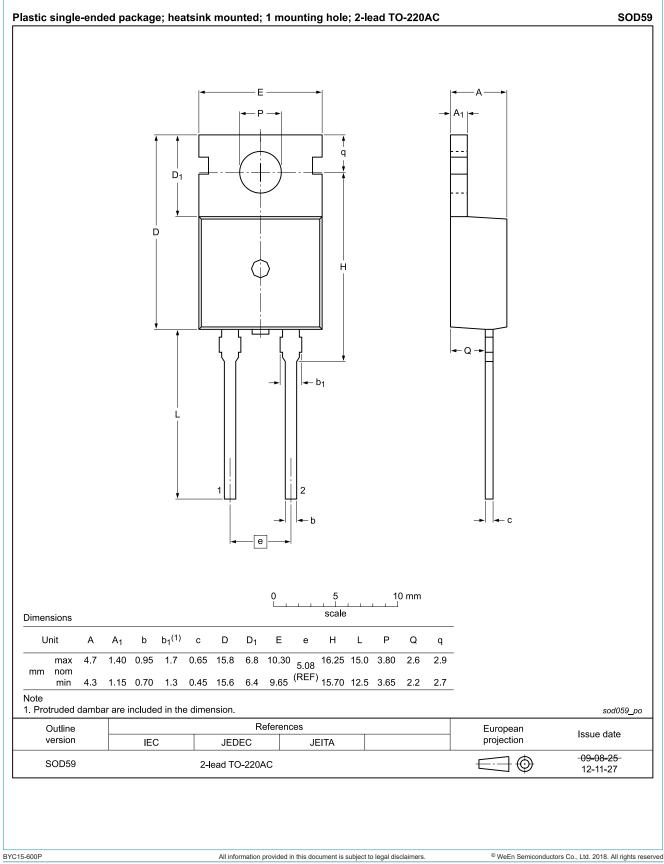
Symbol	Parameter	ameter Conditions				Unit
Static cha	racteristics	· · · · · ·				
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 15 A; T <sub>j</sub> = 25 °C; <u>Fig. 6</u>	-	2.7	3.2	V
		I <sub>F</sub> = 15 A; T <sub>j</sub> = 150 °C; <u>Fig. 6</u>	-	1.4	2	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 600 V; T <sub>j</sub> = 25 °C	-	-	10	μA
		V <sub>R</sub> = 600 V; T <sub>j</sub> = 150 °C	-	-	1	mA
Dynamic	characteristics					,
Q <sub>r</sub>	recovered charge	$I_F = 15 \text{ A}; V_R = 200 \text{ V}; \text{ d}I_F/\text{d}t = 200 \text{ A}/$ $\mu \text{s}; T_j = 25 \text{ °C}; \frac{\text{Fig. 7}}{2}$	-	30	-	nC
		$I_F = 15 \text{ A}; V_R = 200 \text{ V}; \text{ d}I_F/\text{d}t = 200 \text{ A}/$ $\mu \text{s}; T_j = 125 ^\circ\text{C}; \text{ Fig. 7}$	-	115	-	nC
t <sub>rr</sub>	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s};$ $T_j = 25 ^\circ\text{C}; \text{ Fig. 7}$	-	13	18	ns
		$I_F = 15 \text{ A}; V_R = 400 \text{ V}; \text{ d}I_F/\text{d}t = 500 \text{ A}/\mu\text{s};$ $T_j = 25 ^\circ\text{C}; \text{ Fig. 7}$	-	22	-	ns
		$I_{F} = 15 \text{ A}; V_{R} = 200 \text{ V}; \text{ d}I_{F}/\text{d}t = 200 \text{ A}/\mu\text{s};$ $T_{j} = 25 ^{\circ}\text{C}; \text{ Fig. 7}$	-	28	-	ns
		$I_{F} = 15 \text{ A}; V_{R} = 200 \text{ V}; \text{ d}I_{F}/\text{d}t = 200 \text{ A}/\mu\text{s};$ $T_{j} = 125 \text{ °C}; \frac{\text{Fig. 7}}{2}$	-	39	-	ns
I <sub>RM</sub>	peak reverse recovery current	$I_{F} = 15 \text{ A}; V_{R} = 200 \text{ V}; \text{ d}I_{F}/\text{d}t = 200 \text{ A}/\mu\text{s}; T_{j} = 25 ^{\circ}\text{C}; \text{ Fig. 7}$	-	2.1	-	A
		$I_F = 15 \text{ A}; V_R = 200 \text{ V}; \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s};$ $T_i = 125 \text{ °C}; Fig. 7$	-	5.8	-	А





#### Fig. 7. Reverse recovery definitions; ramp recovery

# 11. Package outline



### BYC15-600P

#### Hyperfast power diode

## 12. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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